

Features

- Top view 0603 package
- Viewing Angle = ±60°
- Compatible with infrared and vapor phase reflow solder process
- High reliability
- Ultra bright Red
- RoHS compliance

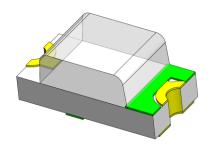
Applications

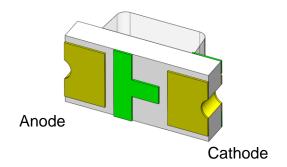
- Optical indicator.
- Switch and Symbol Display.

Description

The RP160806-ATC4 is an AlGaInP Red LED housed in a miniature SMD package. The device has a dominant wavelength of 620nm LED.

Package Outline





Schematic

Cathode
$$\longrightarrow$$
 Anode $(-)$



Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes
lF	Continuous Forward Current	25	mA	
I _{FP}	Peak Forward Current	60	mA	1
V _R	Reverse Voltage	5	V	
Topr	Operating Temperature	-40 ~ +85	°C	
T _{stg}	Storage Temperature	-40 ~ +100	°C	
T _{sol}	Soldering Temperature	260	°C	2
PD	Power Dissipation at(or below) 25°C Free Air Temperature	65	mW	

Electro-Optical Characteristics TA = 25°C (unless otherwise specified)

Optical Characteristics

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
lv	Luminous Intensity	I _F =20mA	150	-	250	mcd	3
λd	Dominant Wavelength	I _F =20mA	617	-	625	nm	
θ1/2	Angle of Half Intensity	I _F =20mA	•	±60	1	deg	

Electrical Characteristics

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
VF	Forward Voltage	I _F =20mA	1.9	-	2.4	V	4
I _R	Reverse Current	V _R =5V	-	-	1	μΑ	

Notes:

- 1. I_{FP} Conditions--Pulse Width≦ 100µs and Duty≦ 10%.
- 2. Soldering time ≤ 10 seconds.



3. Bin Range of Luminous Intensity

Bin Code	Min	Max	Unit	Condition
n	150	180		
О	180	216	mcd	I _F =20mA
р	216	250		

Tolerance of: Luminous Intensity $\pm 10\%$

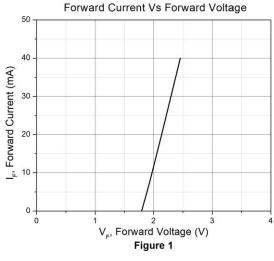
4. Bin Range of Forward Voltage

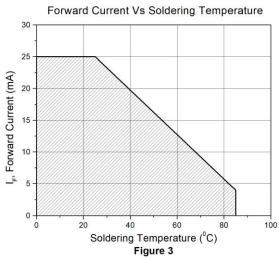
Bin Code	Min	Max	Unit	Condition
a2	1.9	2.0		
а3	2.0	2.1		
a4	2.1	2.2	V	I _F =20mA
а5	2.2	2.3		
а6	2.3	2.4		

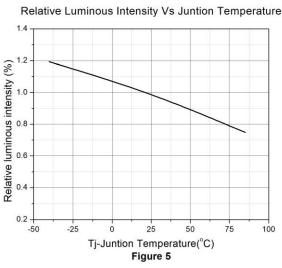
Tolerance of Forward Voltage ± 0.05 V.

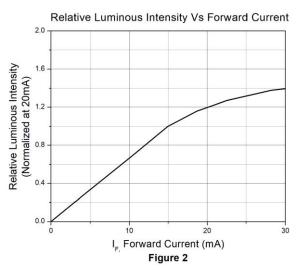


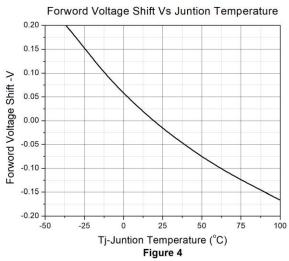
Typical Characteristic Curves

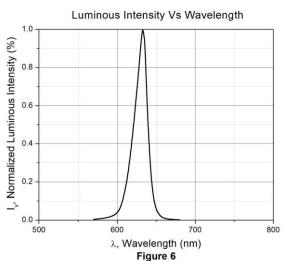






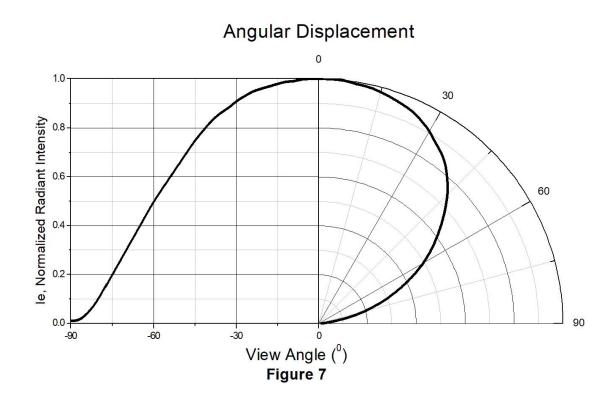






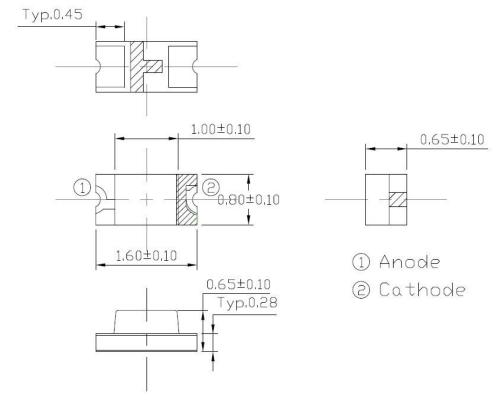


Typical Characteristic Curves



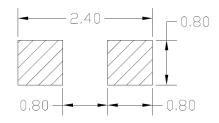


Package Dimension All dimensions are in mm, unless otherwise stated



Note: Tolerance unless mentioned is ±0.1mm.

Recommended Soldering Mask All dimensions are in mm, unless otherwise stated



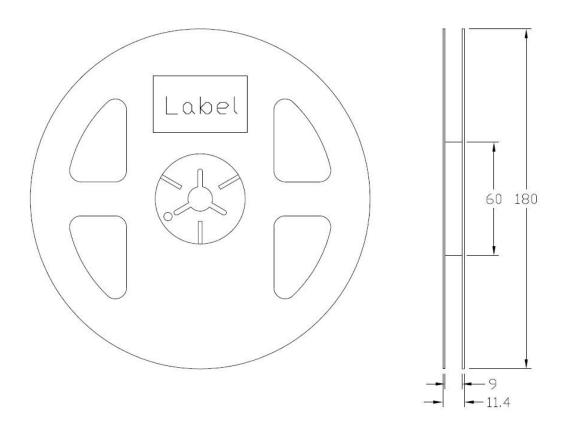
Note: Tolerance unless mentioned is ±0.1mm.

Ordering Information

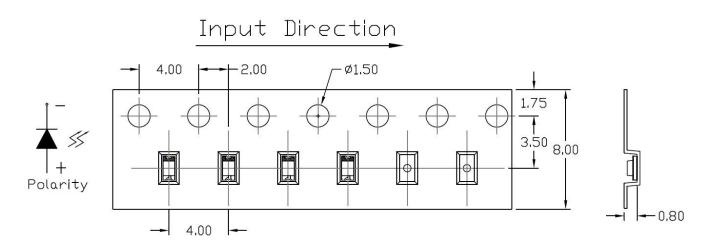
Part Number	Description	Quantity
RP160806-ATC4	Tape & Reel	4000 pcs



Reel Dimension All dimensions are in mm, unless otherwise stated



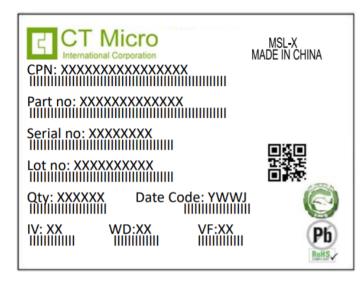
Tape Dimension All dimensions are in mm, unless otherwise stated



Note: Tolerance unless mentioned is ±0.1mm.



Label Form Specification



CPN : Customer Part Number Part no: CTM Production Number

Serial no: Production Number

Lot no: Lot number

Q'ty: Packing Quantity

Date Code: Manufacture Date IV: Bin Code of Luminous Intensity

WD : Bin Code of Dominant Wavelength

VF : Bin Code of Forward Voltage

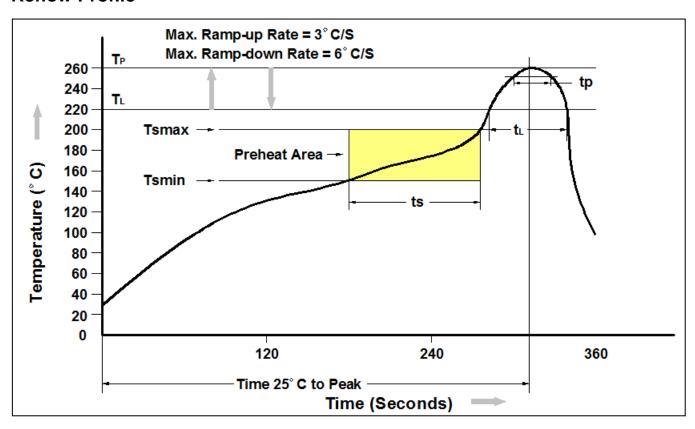
MADE IN CHINA: Production Place

Storage Condition

- 1. Do not open moisture proof bag before the products are ready to use.
- 2. The moisture barrier bag should be stored at 30°C and 90%R.H. max. before opening. Shelf life of non-opened bag is 12 months after the bag sealing date.
- 3. After opening the moisture barrier bag floor life is 1 year at 30°C/60%RH. max. Unused LEDs should be resealed into moisture barrier bag. (Refer to J-STD-020 Standard)
- 4. If the moisture absorbent material has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the J-STD-033 Standard conditions.



Reflow Profile



Profile Feature	Pb-Free Assembly Profile	
Temperature Min. (Tsmin)	150°C	
Temperature Max. (Tsmax)	200°C	
Time (ts) from (Tsmin to Tsmax)	60-120 seconds	
Ramp-up Rate (t∟ to t⊳)	3°C/second max.	
Liquidous Temperature (T _L)	217°C	
Time (t _L) Maintained Above (T _L)	60 – 150 seconds	
Peak Body Package Temperature	260°C +0°C / -5°C	
Time (t _P) within 5°C of 260°C	30 seconds	
Ramp-down Rate (T _P to T _L)	6°C/second max	
Time 25°C to Peak Temperature	8 minutes max.	



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